

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Inventor(s): Ju Hyun KIM et al.

Confirmation No.9586

U.S. Patent Application No. 10/810,634

Group Art Unit: 2823

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Examiner: FERNANDO L TOLEDO

For: **METHOD FOR SEPARATING SAPPHIRE WAFER INTO CHIPS USING DRY-ETCHING**

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the documents listed on the attached form PTO-SB/08A.

This Information Disclosure Statement is being filed under Rule 37 CFR 1.97(i), wherein applicants are submitting references before the grant of a patent to be placed in the file but not considered by the Patent Office. Accordingly, copies of the references as listed on the attached Form PTO-SB/08A are submitted herewith for placement in the file. No certification or fees are deemed necessary.

Respectfully submitted,

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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.